

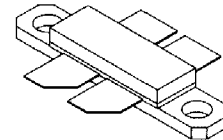
The RF MOSFET Line RF Power Field-Effect Transistor N-Channel Enhancement-Mode Lateral MOSFET

Designed for broadband commercial and industrial applications with frequencies from 470 – 860 MHz. The high gain and broadband performance of this device make it ideal for large-signal, common source amplifier applications in 28 volt transmitter equipment.

- Typical Two-Tone Performance @ 860 MHz, 28 Volts, Narrowband Fixture
Output Power – 100 Watts PEP
Power Gain – 13.5 dB
Efficiency – 36%
IMD – -31 dBc
- Typical Performance at 860 MHz, 28 Volts, Broadband Fixture
Output Power – 100 Watts PEP
Power Gain – 12 dB
Efficiency – 36%
IMD – -34 dBc
- 100% Tested for Load Mismatch Stress at All Phase Angles with 5:1 VSWR @ 28 Vdc, 860 MHz, 100 Watts CW
- Excellent Thermal Stability
- Characterized with Differential Large-Signal Impedance Parameters

MRF374

470 – 860 MHz, 100 W, 28 V
LATERAL N-CHANNEL
BROADBAND
RF POWER MOSFET



CASE 375F-04
NI-650

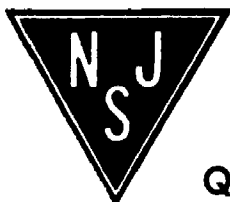
MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain-Source Voltage	V_{DSS}	65	Vdc
Gate-Source Voltage	V_{GS}	± 20	Vdc
Drain Current – Continuous (per Side)	I_D	7	Adc
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	270 1.25	W W/ $^\circ\text{C}$
Storage Temperature Range	T_{stg}	- 65 to +150	$^\circ\text{C}$
Operating Junction Temperature	T_J	200	$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	0.65	$^\circ\text{C}/\text{W}$

NOTE – **CAUTION** – MOS devices are susceptible to damage from electrostatic charge. Reasonable precautions in handling and packaging MOS devices should be observed.



ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Drain-Source Breakdown Voltage (per Side) ($V_{GS} = 0 \text{ Vdc}$, $I_D = 1 \mu\text{A}$ per Side)	$V_{(BR)DSS}$	65	-	-	Vdc
Zero Gate Voltage Drain Current (per Side) ($V_{DS} = 28 \text{ Vdc}$, $V_{GS} = 0 \text{ Vdc}$)	I_{DSS}	-	-	1	μAdc
Gate-Source Leakage Current (per Side) ($V_{GS} = 20 \text{ Vdc}$, $V_{DS} = 0 \text{ Vdc}$)	I_{GSS}	-	-	1	μAdc

ON CHARACTERISTICS

Gate Threshold Voltage (per Side) ($V_{DS} = 10 \text{ V}$, $I_D = 200 \mu\text{A}$ per Side)	$V_{GS(th)}$	2	3.5	4	Vdc
Gate Quiescent Voltage (per Side) ($V_{DS} = 28 \text{ V}$, $I_D = 100 \text{ mA}$ per Side)	$V_{GS(Q)}$	3	4.2	5	Vdc
Drain-Source On-Voltage (per Side) ($V_{GS} = 10 \text{ V}$, $I_D = 3 \text{ A}$ per Side)	$V_{DS(on)}$	-	0.56	0.8	Vdc
Forward Transconductance (per Side) ($V_{DS} = 10 \text{ V}$, $I_D = 3 \text{ A}$ per Side)	g_{fs}	2.2	2.8	-	S

DYNAMIC CHARACTERISTICS (1)

Input Capacitance (per Side) ($V_{DS} = 28 \text{ V}$, $V_{GS} = 0 \text{ V}$, $f = 1 \text{ MHz}$)	C_{iss}	-	80	-	pF
Output Capacitance (per Side) ($V_{DS} = 28 \text{ V}$, $V_{GS} = 0 \text{ V}$, $f = 1 \text{ MHz}$)	C_{oss}	-	45	-	pF
Reverse Transfer Capacitance (per Side) ($V_{DS} = 28 \text{ V}$, $V_{GS} = 0 \text{ V}$, $f = 1 \text{ MHz}$)	C_{rss}	-	3.5	-	pF

FUNCTIONAL CHARACTERISTICS, TWO-TONE TESTING (2)

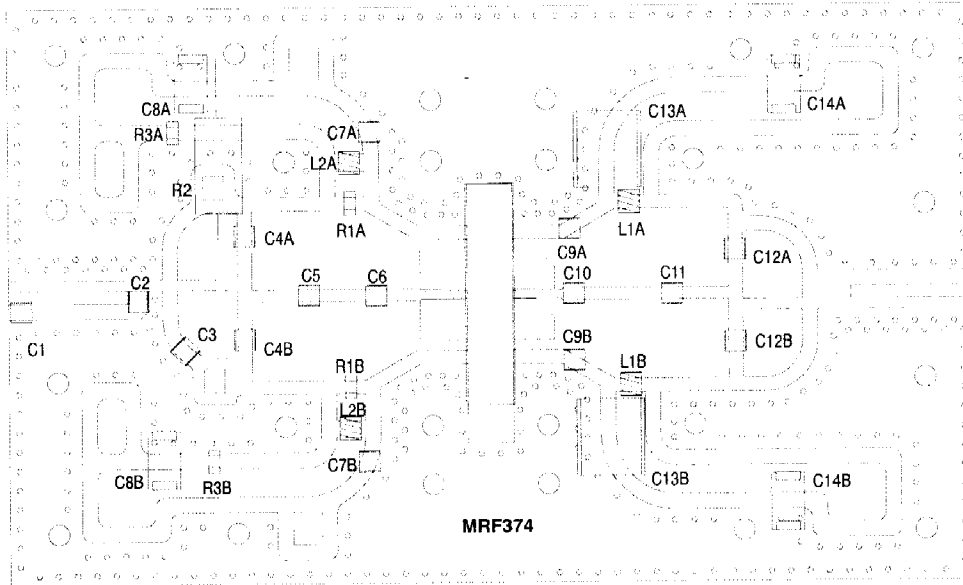
Common Source Power Gain ($V_{DD} = 28 \text{ Vdc}$, $P_{out} = 100 \text{ W PEP}$, $I_{DQ} = 400 \text{ mA}$, $f_1 = 857 \text{ MHz}$, $f_2 = 863 \text{ MHz}$)	G_{ps}	12.5	13.5	-	dB
Drain Efficiency ($V_{DD} = 28 \text{ Vdc}$, $P_{out} = 100 \text{ W PEP}$, $I_{DQ} = 400 \text{ mA}$, $f_1 = 857 \text{ MHz}$, $f_2 = 863 \text{ MHz}$)	η	30	36	-	%
Intermodulation Distortion ($V_{DD} = 28 \text{ Vdc}$, $P_{out} = 100 \text{ W PEP}$, $I_{DQ} = 400 \text{ mA}$, $f_1 = 857 \text{ MHz}$, $f_2 = 863 \text{ MHz}$)	IMD	-28	-31	-	dB
Load Mismatch ($V_{DD} = 28 \text{ Vdc}$, $P_{out} = 100 \text{ W CW}$, $I_{DQ} = 400 \text{ mA}$, $f = 860 \text{ MHz}$, VSWR 5:1 at All Phase Angles of Test)		No Degradation in Output Power			

TYPICAL TWO-TONE BROADBAND

Common Source Power Gain ($V_{DD} = 28 \text{ Vdc}$, $P_{out} = 100 \text{ W PEP}$, $I_{DQ} = 500 \text{ mA}$, $f_1 = 857 \text{ MHz}$, $f_2 = 863 \text{ MHz}$)	G_{ps}	-	12	-	dB
Drain Efficiency ($V_{DD} = 28 \text{ Vdc}$, $P_{out} = 100 \text{ W PEP}$, $I_{DQ} = 500 \text{ mA}$, $f_1 = 857 \text{ MHz}$, $f_2 = 863 \text{ MHz}$)	η	-	36	-	%
Intermodulation Distortion ($V_{DD} = 28 \text{ Vdc}$, $P_{out} = 100 \text{ W PEP}$, $I_{DQ} = 500 \text{ mA}$, $f_1 = 857 \text{ MHz}$, $f_2 = 863 \text{ MHz}$)	IMD	-	-34	-	dB

(1) Each side of device measured separately.

(2) Measured in push-pull configuration.



Vertical Balun Mounting Detail

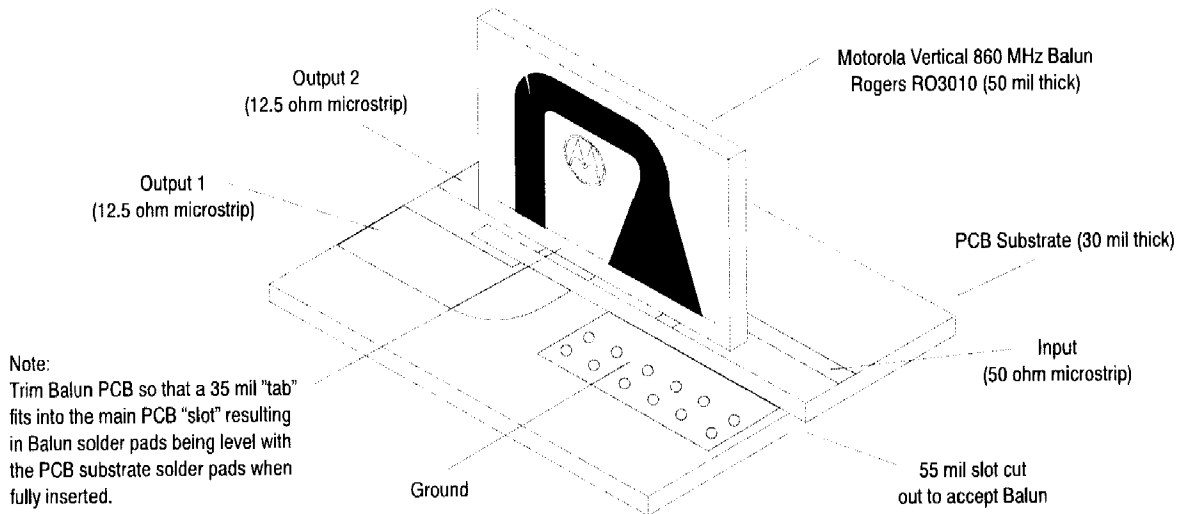


Figure 1. Narrowband Component Layout

